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### **IR Receiver Modules for Remote Control Systems**



#### **LINKS TO ADDITIONAL RESOURCES**







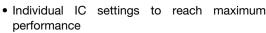


#### **DESCRIPTION**

This IR receiver series is optimized for long burst remote control systems in different environments. The customer can chose between different IC settings (AGC variants), to find the optimum solution for his application. The higher the AGC, the better noise is suppressed, but the lower the code compatibility.

The devices contain a PIN diode and a preamplifier assembled on a lead frame. The epoxy package contains an IR filter. The demodulated output signal can be directly connected to a microprocessor for decoding. These components have not been qualified to automotive specifications.

#### **FEATURES**





- · Immunity against noise (lamps, LCD TV, Wi-Fi)
- Low supply current
- · Photo detector and preamplifier in one package
- Supply voltage: 2.0 V to 5.5 V
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912



FREE **GREEN** (5-2008)

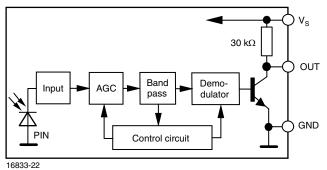
#### **APPLICATIONS**

· Infrared remote control systems

#### **DESIGN SUPPORT TOOLS**

- 3D models
- Window size calculator

#### **BLOCK DIAGRAM**



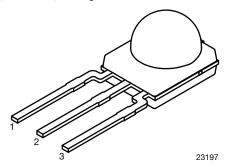


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#### **MECHANICAL DATA**

Pinning for TSOP53...DF1P:

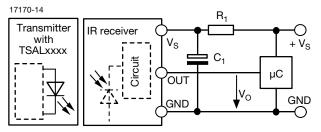
 $1 = OUT, 2 = GND, 3 = V_S$ 



#### **ORDERING CODE**

TSOP53...DF1P - 1100 pieces in tape and reel

#### **APPLICATION CIRCUIT**



 $\mathrm{R}_1$  and  $\mathrm{C}_1$  recommended in case there are strong ripple or spikes on the supply line.

PARTS TABLE			
AGC		LEGACY, FOR LONG BURST REMOTE CONTROLS (AGC2)	RECOMMENDED FOR LONG BURST CODES (AGC4)
	30 kHz	TSOP53230DF1P	TSOP53430DF1P
	33 kHz	TSOP53233DF1P	TSOP53433DF1P
Carrier frequency	36 kHz	TSOP53236DF1P	TSOP53436DF1P (1)(2)(3)
Carrier frequency	38 kHz	TSOP53238DF1P	TSOP53438DF1P (4)(5)(6)(9)(10)
	40 kHz	TSOP53240DF1P (8)	TSOP53440DF1P
	56 kHz	TSOP53256DF1P (11)	TSOP53456DF1P (6)(7)
Package		Miniı	mold
Pinning		1 = OUT, 2 =	GND, 3 = V <sub>S</sub>
Dimensions (mm)		5.4 W x 6.3	5 H x 4.9 D
Mounting		Lea	ded
Application		Remote	control
Best choice for		(1) RC-5 (2) RC-6 (3) Panasonic (4) NEC (8) Sony (9) Mitsubishi (1)	C <sup>(5)</sup> Sharp <sup>(6)</sup> r-step <sup>(7)</sup> Thomson RCA <sup>(0)</sup> Sejin 4PPM <sup>(11)</sup> Cisco
Special options		Narrow optical filter: <a href="https://www.vishay.com/doc?8159">www.vishay.com/doc?8159</a> Wide optical filter: <a href="https://www.vishay.com/doc?82726">www.vishay.com/doc?82726</a>	0

ABSOLUTE MAXIMUM F	RATINGS			
PARAMETER	TEST CONDITION	SYMBOL	VALUE	UNIT
Supply voltage		Vs	-0.3 to +6	V
Supply current		I <sub>S</sub>	5	mA
Output voltage		V <sub>O</sub>	-0.3 to 5.5	V
Voltage at output to supply		V <sub>S</sub> - V <sub>O</sub>	-0.3 to (V <sub>S</sub> + 0.3)	V
Output current		I <sub>O</sub>	5	mA
Junction temperature		Tj	100	°C
Storage temperature range		T <sub>stg</sub>	-25 to +85	°C
Operating temperature range		T <sub>amb</sub>	-25 to +85	°C
Power consumption	T <sub>amb</sub> ≤ 85 °C	P <sub>tot</sub>	10	mW
Soldering temperature	t ≤ 10 s, 1 mm from case	T <sub>sd</sub>	260	°C

#### Note

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only
and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of this specification
is not implied. Exposure to absolute maximum rating conditions for extended periods may affect the device reliability



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ELECTRICAL AND OPT	ICAL CHARACTERISTICS	(T <sub>amb</sub> = 25 °	°C, unless o	otherwise s	pecified)	
PARAMETER	TEST CONDITION	SYMBOL	MIN.	TYP.	MAX.	UNIT
Supply ourrent	$E_{V} = 0, V_{S} = 3.3 \text{ V}$	I <sub>SD</sub>	0.25	0.35	0.45	mA
Supply current	E <sub>v</sub> = 40 klx, sunlight	I <sub>SH</sub>	-	0.45	-	mA
Supply voltage		Vs	2.0	-	5.5	V
Transmission distance	$E_{V}=0$ , test signal see Fig. 1, IR diode TSAL6200, $I_{F}=50\ \text{mA}$	d	-	24	-	m
Output voltage low	I <sub>OSL</sub> = 0.5 mA, E <sub>e</sub> = 0.7 mW/m <sup>2</sup> , test signal see Fig. 1	V <sub>OSL</sub>	-	-	100	mV
Minimum irradiance	Test signal: RC5 code	E <sub>e min.</sub>	-	0.12	0.25	mW/m <sup>2</sup>
Minimum irradiance	Test signal: NEC code	E <sub>e min.</sub>	-	0.16	0.35	mW/m <sup>2</sup>
Maximum irradiance	t <sub>pi</sub> - 4/f <sub>o</sub> < t <sub>po</sub> < t <sub>pi</sub> + 4/f <sub>o</sub> , test signal see Fig. 1	E <sub>e max.</sub>	30	-	-	W/m <sup>2</sup>
Directivity	Angle of half transmission distance	Ψ1/2	-	± 45	-	deg

### TYPICAL CHARACTERISTICS (T<sub>amb</sub> = 25 °C, unless otherwise specified)

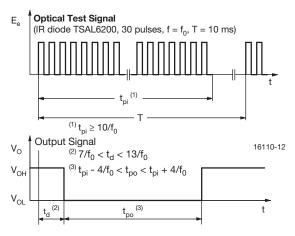
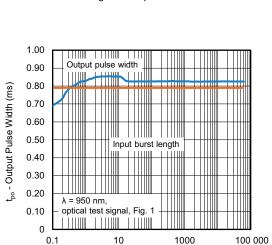
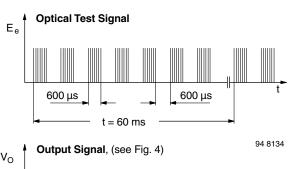


Fig. 1 - Output Active Low



 ${\rm E_e \, - \, Irradiance \, (mW/m^2)}$  Fig. 2 - Pulse Length and Sensitivity in Dark Ambient



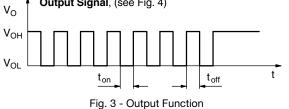


Fig. 3 - Output Function

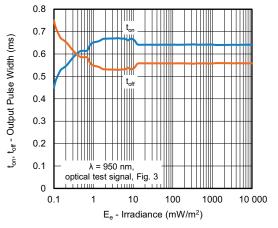


Fig. 4 - Output Pulse Diagram



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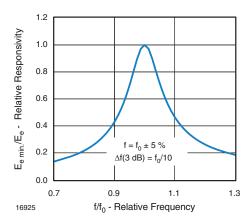


Fig. 5 - Frequency Dependence of Responsivity

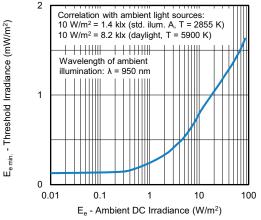


Fig. 6 - Sensitivity in Bright Ambient

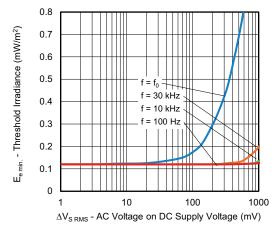


Fig. 7 - Sensitivity vs. Supply Voltage Disturbances

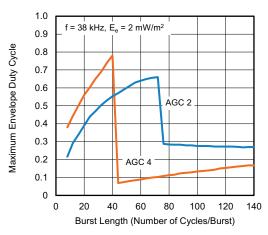


Fig. 8 - Max. Envelope Duty Cycle vs. Burst Length

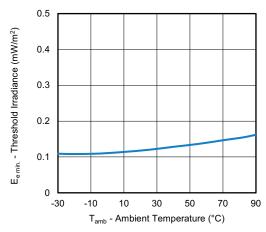


Fig. 9 - Sensitivity vs. Ambient Temperature

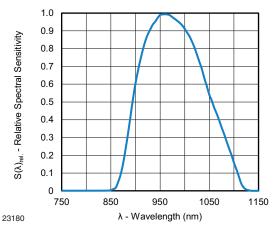


Fig. 10 - Relative Spectral Sensitivity vs. Wavelength



0.8

0.4 0.2

# TSOP532..DF1P, TSOP534..DF1P

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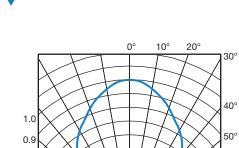


Fig. 11 - Horizontal Directivity

0 d<sub>rel</sub> - Relative Transmission Distance 60°

70°

80°

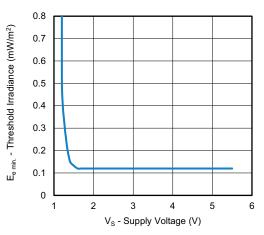


Fig. 12 - Sensitivity vs. Supply Voltage



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#### **SUITABLE DATA FORMAT**

This series is designed to suppress spurious output pulses due to noise or disturbance signals. The devices can distinguish data signals from noise due to differences in frequency, burst length, and envelope duty cycle. The data signal should be close to the device's band-pass center frequency (e.g. 38 kHz) and fulfill the conditions in the table below.

When a data signal is applied to the product in the presence of a disturbance, the sensitivity of the receiver is automatically reduced by the AGC to insure that no spurious pulses are present at the receiver's output. Some examples which are suppressed are:

- DC light (e.g. from tungsten bulbs sunlight)
- · Continuous signals at any frequency
- Strongly or weakly modulated patterns from fluorescent lamps with electronic ballasts (see Fig. 13 or Fig. 14).
- 2.4 GHz and 5 GHz Wi-Fi

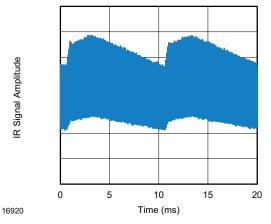


Fig. 13 - IR Disturbance from Fluorescent Lamp With Low Modulation

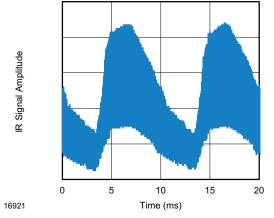


Fig. 14 - IR Disturbance from Fluorescent Lamp With High Modulation

	TSOP532DF1P	TSOP534DF1P
Minimum burst length	10 cycles/burst	10 cycles/burst
After each burst of length a minimum gap time is required of	10 to 72 cycles ≥ 10 cycles	10 to 40 cycles ≥ 10 cycles
For bursts greater than a minimum gap time in the data stream is needed of	72 cycles > 3 x burst length	40 cycles > 10 x burst length
Maximum number of continuous short bursts/second	950	1500
NEC code	Yes	Preferred
RC5/RC6 code	Yes	Preferred
Thomson RCA 56 kHz code	Yes	Preferred
Sharp code	Yes	Preferred
Sony code	Preferred	No
r-step code	Yes	Preferred
Suppression of interference from fluorescent lamps	Mild disturbance patterns are suppressed (example: signal pattern of Fig. 13)	Complex and critical disturbance patterns are suppressed (example: signal pattern of Fig. 14 or highly dimmed LCDs)

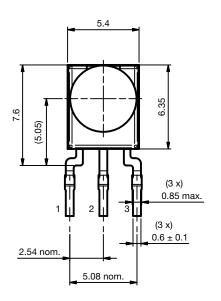
#### Note

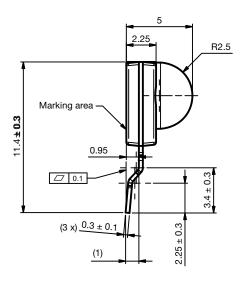
• For data formats with short bursts please see the datasheet of TSOP531..DF1P, TSOP533..DF1P, TSOP535..DF1P



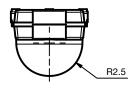
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### PACKAGE DIMENSIONS in millimeters

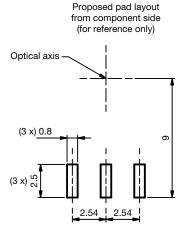




Not indicated tolerances ± 0.2







Drawing-No.: 6.550-5343.01-4

Issue: 2; 02.07.19



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#### **ASSEMBLY INSTRUCTIONS**

#### **Reflow Soldering**

 Reflow soldering must be done within 72 h while stored under a max. temperature of 30 °C, 60 % RH after opening the dry pack envelope

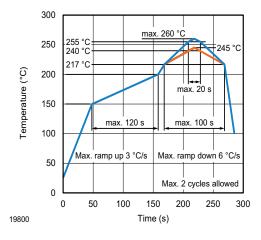
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- Set the furnace temperatures for pre-heating and heating in accordance with the reflow temperature profile as shown in the diagram. Exercise extreme care to keep the maximum temperature below 260 °C. The temperature shown in the profile means the temperature at the device surface. Since there is a temperature difference between the component and the circuit board, it should be verified that the temperature of the device is accurately being measured
- Handling after reflow should be done only after the work surface has been cooled off

#### **Manual Soldering**

- Use a soldering iron of 25 W or less. Adjust the temperature of the soldering iron below 300 °C
- Finish soldering within 3 s
- Handle products only after the temperature has cooled off

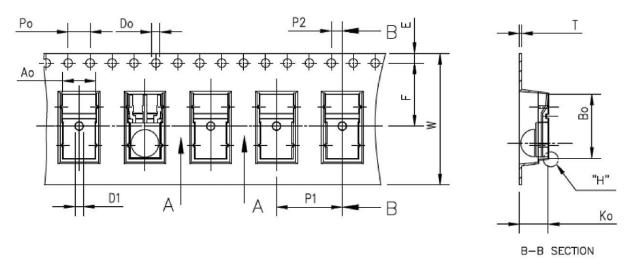
#### **VISHAY LEAD (Pb)-FREE REFLOW SOLDER PROFILE**

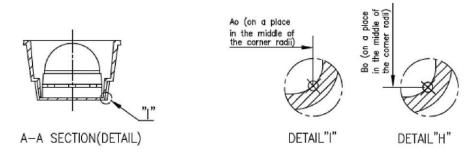




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#### **PACKAGING DIMENSIONS** in millimeters





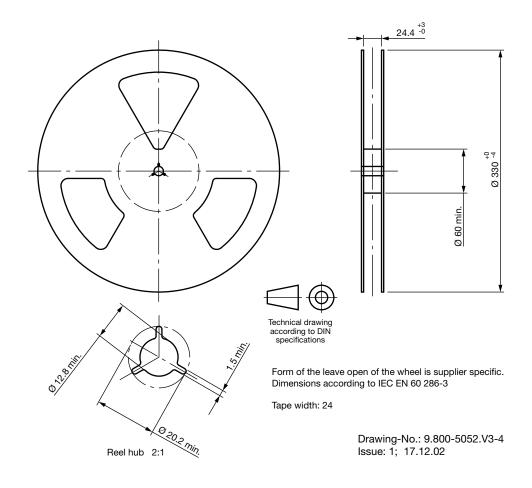
Drawing-No.: 9.700-5399.01-4

Issue: 2; 29.06.18

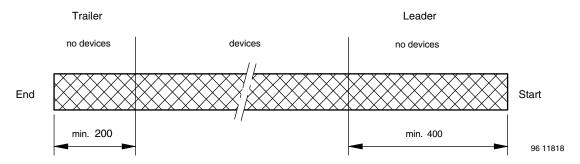
Item	A <sub>0</sub>	B <sub>0</sub>	K <sub>0</sub>	P <sub>0</sub>	P <sub>1</sub>	P <sub>2</sub>	Т
Dimensions	6.08 ± 0.10	11.75 ± 0.10	5.25 ± 0.10	$4.0 \pm 0.10$	12.0 ± 0.10	$2.0 \pm 0.10$	$0.40 \pm 0.05$
Item	E	F	$D_0$	D <sub>1</sub>	W	10P <sub>0</sub>	
Dimensions	1.75 ± 0.10	11.50 ± 0.10	1.55 ± 0.05	1.5 min.	24.0 +0.30 / -0.10	40.0 ± 0.20	

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#### **REEL DIMENSIONS** in millimeters



#### **LEADER AND TRAILER DIMENSIONS** in millimeters



#### **COVER TAPE PEEL STRENGTH**

According to DIN EN 60286-3

0.1 N to 1.3 N

300 mm/min. ± 10 mm/min.

 $165^{\circ}$  to  $180^{\circ}$  peel angle

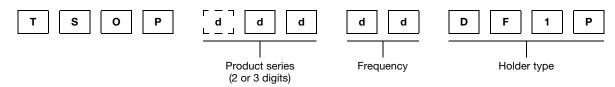
#### Datasheet Values Refer to PCN-OPT-1225-2022-REV-0



### TSOP532..DF1P, TSOP534..DF1P

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#### **ORDERING INFORMATION**



#### Note

• d = "digit", please consult the list of available series on the previous page to create a valid part number

Example: TSOP53238DF1P

#### **PACKAGING QUANTITY**

- 1100 pieces per reel
- 1 reel per box

#### **LABEL**

#### Standard bar code labels for finished goods

The standard bar code labels are product labels and used for identification of goods. The finished goods are packed in final packing area. The standard packing units are labeled with standard bar code labels before transported as finished goods to warehouses. The labels are on each packing unit and contain Vishay Semiconductor GmbH specific data.

PLAIN WRITING	ABBREVIATION	LENGTH
Item-description	-	18
Item-number	INO	8
Selection-code	SEL	3
LOT-/serial-number	BATCH	10
Data-code	COD	3 (YWW)
Plant-code	PTC	2
Quantity	QTY	8
Accepted by	ACC	-
Packed by	PCK	-
Mixed code indicator	MIXED CODE	-
Origin	XXXXXXX+	Company logo
LONG BAR CODE TOP	TYPE	LENGTH
Item-number	N	8
Plant-code	N	2
Sequence-number	X	3
Quantity	N	8
Total length	-	21
SHORT BAR CODE BOTTOM	TYPE	LENGTH
Selection-code	X	3
Data-code	N	3
Batch-number	X	10
Filter	-	1
Total length	-	17

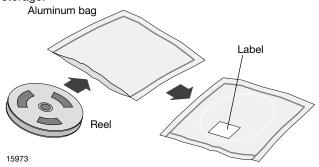


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## **DRY PACKING**

The reel is packed in an anti-humidity bag to protect the devices from absorbing moisture during transportation and

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#### **FINAL PACKING**

The sealed reel is packed into a cardboard box. A secondary cardboard box is used for shipping purposes.

#### RECOMMENDED METHOD OF STORAGE

Dry box storage is recommended as soon as the aluminum bag has been opened to prevent moisture absorption. The following conditions should be observed, if dry boxes are not available:

- Storage temperature 10 °C to 30 °C
- Storage humidity ≤ 60 % RH max.

After more than 72 h under these conditions moisture content will be too high for reflow soldering.

In case of moisture absorption, the devices will recover to the former condition by drying under the following condition: 192 h at 40 °C + 5 °C / - 0 °C and < 5 % RH (dry air / 96 h at 60 °C + 5 °C and < 5 % RH for all device containers

24 h at 125 °C + 5 °C not suitable for reel or tubes.

An EIA JEDEC® standard J-STD-020 level 4 label is included on all dry bags.

### LEVEL CAUTION This bag contains MOISTURE-SENSITIVE DEVICES 1. Shelf life in sealed bag: 12 months at < 40 °C and < 90 % relative 2. After this bag is opened, devices that will be subjected to soldering reflow or equivalent processing (peak package body temp. 260 $^{\circ}\text{C})$ must be 2a. Mounted within 72 hours at factory condition of < 30 °C/60 % RH or 2b. Stored at < 5 % RH 3. Devices require baking befor mounting if: Humidity Indicator Card is > 10 % when read at 23 °C $\pm$ 5 °C or 2a. or 2b. are not met. If baking is required, devices may be baked for: 192 hours at 40 °C+5 °C/-0 °C and < 5 % RH (dry air/nitrogen) or 96 hours at 60 °C±5 °C and < 5 % RH for all device containers or 24 hours at 125 °C±5 °C not suitable for reels or tubes

EIA JEDEC standard J-STD-020 level 4 label is included on all dry bags

Note: Level and body temperature defined by EIA JEDEC Standard J-STD-020

(If blank, see barcode label)

#### **ESD PRECAUTION**

Proper storage and handling procedures should be followed to prevent ESD damage to the devices especially when they are removed from the antistatic shielding bag. Electrostatic sensitive devices warning labels are on the packaging.

#### **VISHAY SEMICONDUCTORS STANDARD BAR CODE LABELS**

The Vishay Semiconductors standard bar code labels are printed at final packing areas. The labels are on each packing unit and contain Vishay Semiconductors specific data.



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